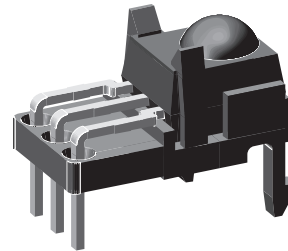


Photo Modules for PCM Remote Control Systems

Description

The TSOP341..LL1 - series are miniaturized receivers for infrared remote control systems. PIN diode and preamplifier are assembled on lead frame, the epoxy package is designed as IR filter.

The demodulated output signal can directly be decoded by a microprocessor. The main benefits are the low supply voltage of 3 V and the compatibility to all kind of data formats.



16644

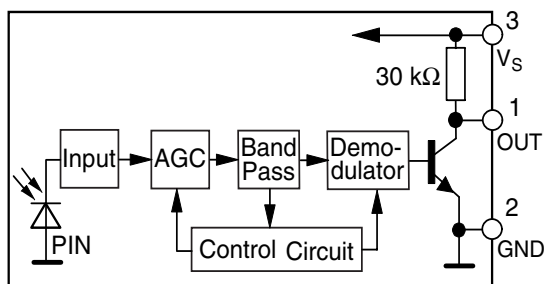
Features

- Internal filter for PCM frequency
- Improved shielding against electrical field disturbance
- TTL and CMOS compatibility
- Low supply voltage: 3 V
- Low power consumption
- High immunity against ambient light
- Enhanced data rate up to 4000 bit/s
- Operation with short short bursts possible (≥ 6 cycles/burst)

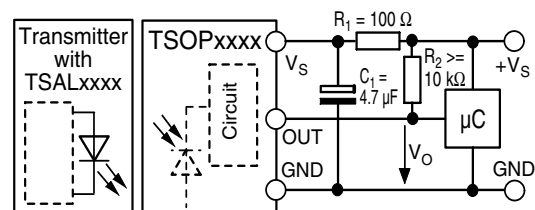
Parts Table

Part	Carrier Frequency
TSOP34130LL1	30 kHz
TSOP34133LL1	33 kHz
TSOP34136LL1	36 kHz
TSOP34137LL1	36.7 kHz
TSOP34138LL1	38 kHz
TSOP34140LL1	40 kHz
TSOP34156LL1	56 kHz

Block Diagram



Application Circuit



$R_1 + C_1$ recommended to suppress power supply disturbances.

R_2 optional for improved pulse forming.

Absolute Maximum Ratings

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Supply Voltage	(Pin 3)	V_S	- 0.3 to + 6.0	V
Supply Current	(Pin 3)	I_S	5	mA
Output Voltage	(Pin 1)	V_O	- 0.3 to + 6.0	V
Output Current	(Pin 1)	I_O	5	mA
Junction Temperature		T_j	100	$^{\circ}\text{C}$
Storage Temperature Range		T_{stg}	- 25 to + 85	$^{\circ}\text{C}$
Operating Temperature Range		T_{amb}	- 25 to + 85	$^{\circ}\text{C}$
Power Consumption	($T_{amb} \leq 85\text{ }^{\circ}\text{C}$)	P_{tot}	50	mW
Soldering Temperature	$t \leq 5\text{ s}$, 1 mm from case	T_{sd}	260	$^{\circ}\text{C}$

Electrical and Optical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Supply Current	$V_S = 3\text{ V}$, $E_V = 0$	I_{SD}	0.8	1.3	1.5	mA
	$V_S = 3\text{ V}$, $E_V = 40\text{ klx}$, sunlight	I_{SH}		1.4		mA
Supply Voltage	$T_{amb} = - 25\text{ }^{\circ}\text{C}$ to + 85 $^{\circ}\text{C}$	V_S	2.7		3.6	V
	$T_{amb} = 0\text{ }^{\circ}\text{C}$ to + 60 $^{\circ}\text{C}$, $E_V < 30\text{ klx}$, sunlight	V_S	2.4		3.6	V
Transmission Distance	$E_V = 0$, test signal see fig.1, IR diode TSAL6200, $I_F = 400\text{ mA}$	d		35		m
Output Voltage Low (Pin 4)	$I_{OSL} = 0.5\text{ mA}$, $E_e = 0.7\text{ mW/m}^2$	V_{OSL}			250	mV
Irradiance (30 - 40 kHz)	Pulse width tolerance: $t_{pi} - 4/f_o < t_{po} < t_{pi} + 6/f_o$, test signal see fig.1	$E_{e\ min}$		0.35	0.5	mW/m^2
Irradiance (56 kHz)	Pulse width tolerance: $t_{pi} - 4/f_o < t_{po} < t_{pi} + 6/f_o$, test signal see fig.1	$E_{e\ min}$		0.4	0.6	mW/m^2
Irradiance	$t_{pi} - 4/f_o < t_{po} < t_{pi} + 6/f_o$	$E_{e\ max}$	30			W/m^2
Directivity	Angle of half transmission distance	$\phi_{1/2}$		± 45		deg

Typical Characteristics ($T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

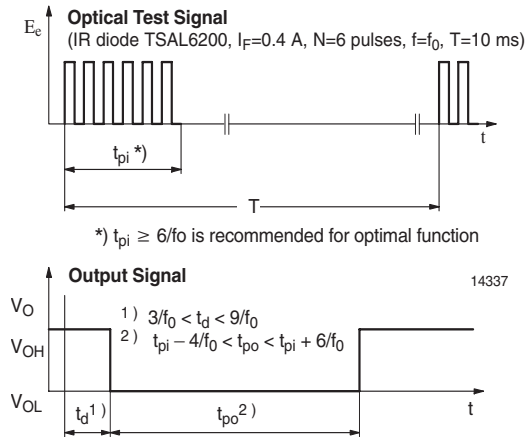


Figure 1. Output Function

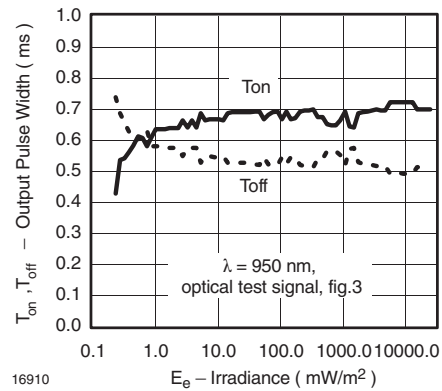


Figure 4. Output Pulse Diagram

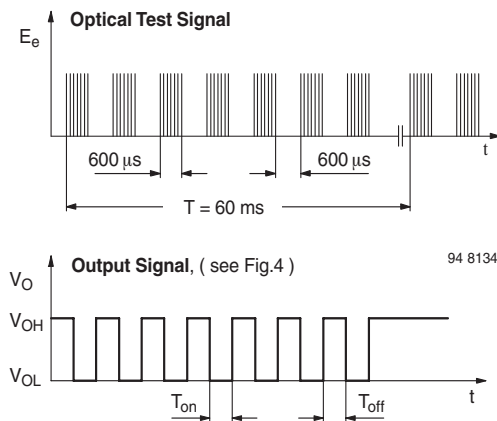


Figure 2. Output Function

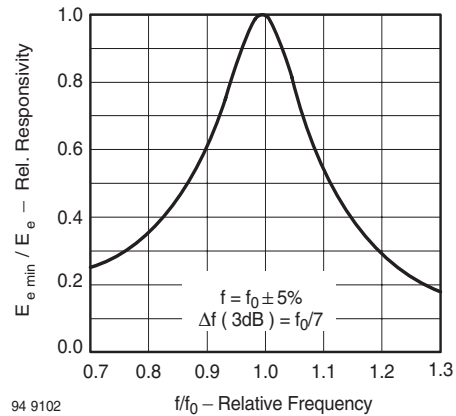


Figure 5. Frequency Dependence of Responsivity

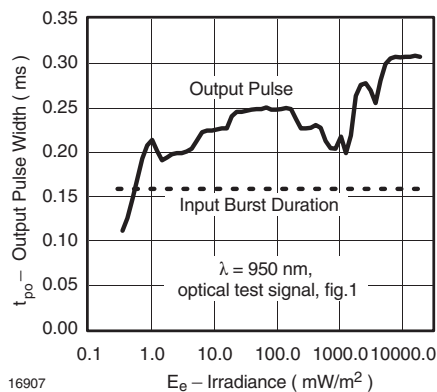


Figure 3. Pulse Length and Sensitivity in Dark Ambient

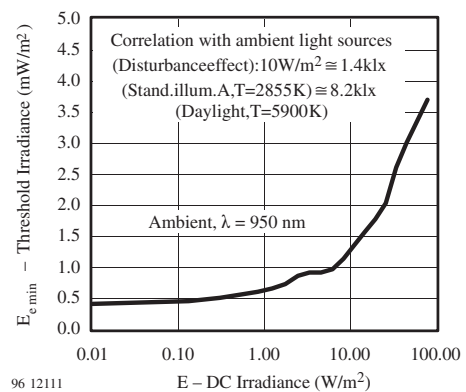


Figure 6. Sensitivity in Bright Ambient

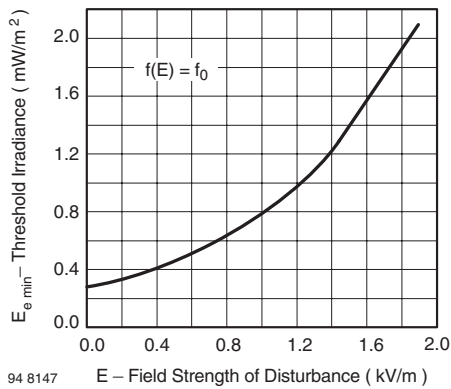


Figure 7. Sensitivity vs. Electric Field Disturbances

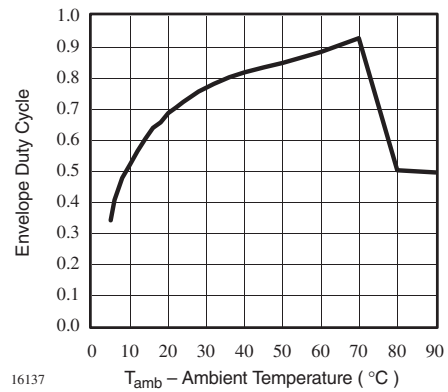


Figure 10. Max. Envelope Duty Cycle vs. Burstlength

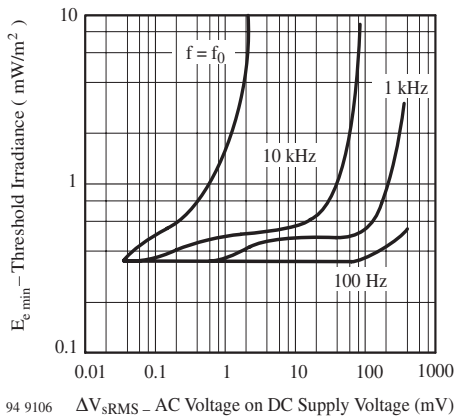


Figure 8. Sensitivity vs. Supply Voltage Disturbances

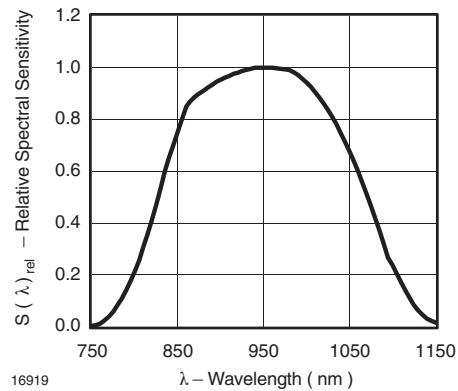


Figure 11. Relative Spectral Sensitivity vs. Wavelength

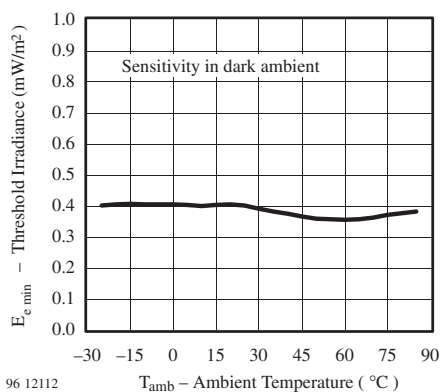


Figure 9. Sensitivity vs. Ambient Temperature

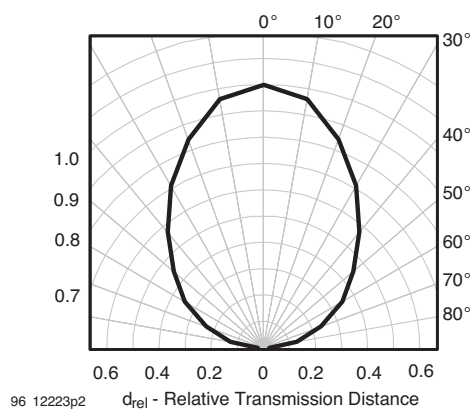


Figure 12. Directivity

Suitable Data Format

The circuit of the TSOP341..LL1 is designed in that way that unexpected output pulses due to noise or disturbance signals are avoided. A bandpass filter, an integrator stage and an automatic gain control are used to suppress such disturbances.

The distinguishing mark between data signal and disturbance signal are carrier frequency, burst length and duty cycle.

The data signal should fulfill the following condition:

- Carrier frequency should be close to center frequency of the bandpass (e.g. 38 kHz).
- Burst length should be 6 cycles/burst or longer.
- After each burst which is between 6 cycles and 70 cycles a gap time of at least 10 cycles is necessary.
- For each burst which is longer than 1.8ms a corresponding gap time is necessary at some time in the data stream. This gap time should have at least same length as the burst.
- Up to 2200 short bursts per second can be received continuously.

Some examples for suitable data format are: NEC Code, Toshiba Micom Format, Sharp Code, RC5 Code, RC6 Code, RCMM Code, R-2000 Code, RECS-80 Code.

When a disturbance signal is applied to the TSOP341..LL1 it can still receive the data signal. However the sensitivity is reduced to that level that no unexpected pulses will occur.

Some examples for such disturbance signals which are suppressed by the TSOP341..LL1 are:

- DC light (e.g. from tungsten bulb or sunlight)
- Continuous signal at 38 kHz or at any other frequency
- Signals from fluorescent lamps with electronic ballast (an example of the signal modulation is in the figure below).

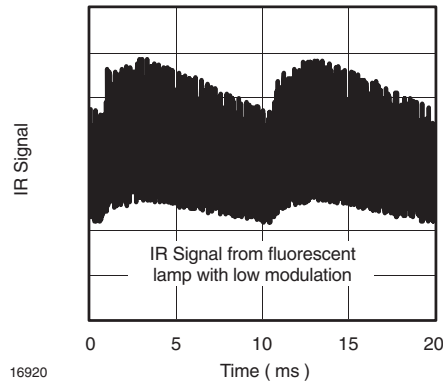


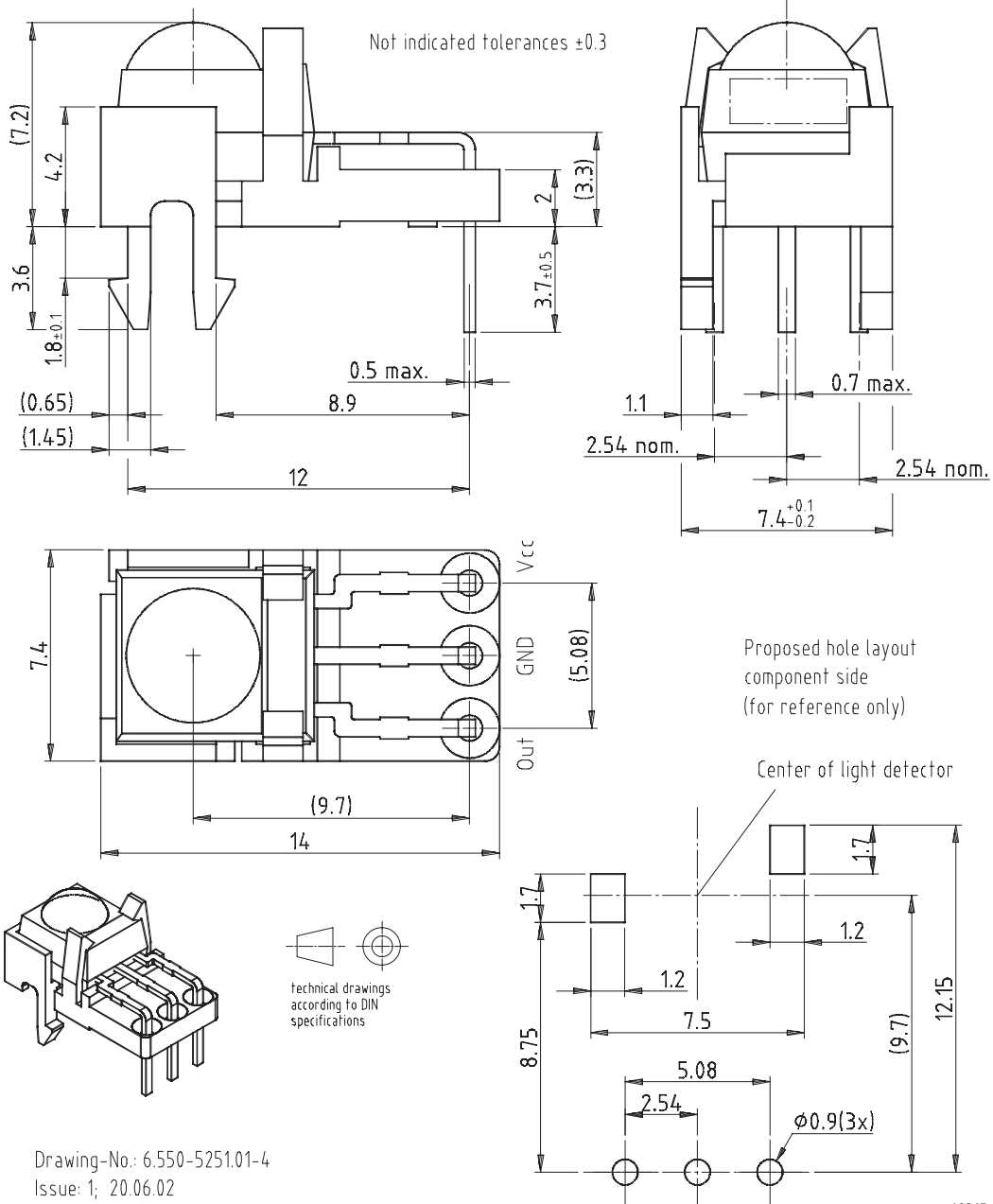
Figure 13. IR Signal from Fluorescent Lamp with low Modulation

TSOP341..LL1

Vishay Semiconductors



Package Dimensions in mm



16845



Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

**We reserve the right to make changes to improve technical design
and may do so without further notice.**

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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